

## Electronic Acknowledgement Receipt

<b>EFS ID:</b>	3226387
<b>Application Number:</b>	10572524
<b>International Application Number:</b>	
<b>Confirmation Number:</b>	4739
<b>Title of Invention:</b>	FABRICATION OF CONDUCTIVE METAL LAYER ON SEMICONDUCTOR DEVICES
<b>First Named Inventor/Applicant Name:</b>	Xuejin KANG
<b>Customer Number:</b>	8791
<b>Filer:</b>	Stephen De Klerk./Ariana Bates
<b>Filer Authorized By:</b>	Stephen De Klerk.
<b>Attorney Docket Number:</b>	007989.P001
<b>Receipt Date:</b>	29-APR-2008
<b>Filing Date:</b>	11-SEP-2007
<b>Time Stamp:</b>	15:49:20
<b>Application Type:</b>	U.S. National Stage under 35 USC 371

### Payment information:

Submitted with Payment	no
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### File Listing:

Document Number	Document Description	File Name	File Size(Bytes) /Message Digest	Multi Part /.zip	Pages (if appl.)
1	Information Disclosure Statement (IDS) Filed	P001IDS042908.pdf	992681 d97ca1b3cd5d9e5d31c3d8ead1902e911667800	no	4

**Warnings:**

**Information:**

This is not an USPTO supplied IDS fillable form

2	Foreign Reference	JP05-291621.pdf	175554 714a99e7d7b1317e4305067b3141a2d4e453a79	no	1
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3	Foreign Reference	JP2000277804.pdf	2293366 86e0305add97d476c3ae281a7257dcd4ea0ab0c1	no	7
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5	Foreign Reference	JP2004072052.pdf	4163594 666a7a11bd550505254ed3dcd4634cc4c143ab058	no	17
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6	Foreign Reference	JP2001313422.pdf	4362986 b05e9ae2115c7385681660cb6a058168978c37	no	13
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9	Foreign Reference	JP2004088083.pdf	8288131 8c43c52b2375617ca307e81882ab9ede4dc8ee514	no	32
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10	Foreign Reference	JP2005012188.pdf	5695037 4c3f0c2e946ea07f6cdede4b1a536501c781ea29	no	22

**Warnings:****Information:**

11	Foreign Reference	TW540171.pdf	186360	no	1
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**Warnings:****Information:**

12	NPL Documents	NPL_UEDA.pdf	1367153	no	4
			012b07122b493a3929835304718a19a3 14b8c5f6		

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Total Files Size (in bytes):			39253816
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**New Applications Under 35 U.S.C. 111**

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

**National Stage of an International Application under 35 U.S.C. 371**

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.

**New International Application Filed with the USPTO as a Receiving Office**

If a new international application is being filed and the international application includes the necessary components for an international filing date (see PCT Article 11 and MPEP 1810), a Notification of the International Application Number and of the International Filing Date (Form PCT/RO/105) will be issued in due course, subject to prescriptions concerning national security, and the date shown on this Acknowledgement Receipt will establish the international filing date of the application.